HALOGEN

FREE

Vishay Siliconix

6.5 m Ω , Bidirectional Battery Switch in Compact WCSP

DESCRIPTION

The SiP32102 bidirectional switch feature reverse blocking capability to isolate the battery from the system. The internal switch has an ultra low 6.5 m Ω (typ at 3.3 V) on-resistance and operates from a +2.3 V to +5.5 V input voltage range, making the devices ideal battery-disconnect switches for high capacity battery applications.

The SiP32102 has slew rate control, making it ideal in large load capacitor as well as high current load switching applications. This device is also highly efficient, consuming only 110 nA (typ.) current in shutdown and while operating.

The SiP32102 has an active high enable. It can interface directly with a low voltage control signal.

The SiP32102 is available in an ultra compact 12-bump, 1.3 mm x 1.7 mm, 0.4 mm pitch WCSP package with top side lamination. The device operates over the temperature of -40 $^{\circ}$ C to +85 $^{\circ}$ C.

FEATURES

- · Bidirectional on and off
- 7 A continuous current capability
- Ultra low $R_{on},\,6.5~m\Omega$ (typ.) at 3.3 V
- Wide input voltage, 2.3 V to 5.5 V
- · Slew rate controlled turn on
- · Low quiescent current: 110 nA
- EN pin with integrated pull up or pull down resistor
- Compact 12-bump, 1.3 mm x 1.7 mm x 0.55 mm WCSP package
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Smartphones and tablets
- Digital still / video cameras
- Portable meters and test instruments
- · Communication devices with embedded batteries
- · Portable medical and healthcare systems
- Data storage
- · Battery bank

TYPICAL APPLICATION CIRCUIT

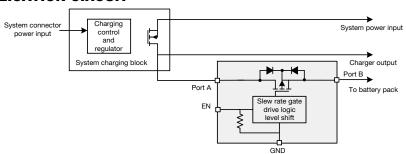


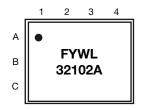
Fig. 1 - Typical Application Circuit

ORDERING INFORMATION							
PART NUMBER	MARKING	ARKING ENABLE ENABLE PULL RESISTO		PACKAGE	TEMPERATURE		
SiP32102DB-T1-GE1	32102A	High	Enable pull Low	12-bump, 1.3 mm x 1.7 mm,	-40 °C to +85 °C		
SiP32102DB-T5-GE1	32102A	High	Enable pull Low	0.4 mm pitch WCSP package	-40 C to +65 C		
SiP32102EVB	-	İ	-	Evaluation board	-		

Note

GE1 denotes halogen-free and RoHS-compliant

MARKING



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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	CONDITIONS	LIMIT	UNIT			
V V	Reference to GND	-0.3 to +6				
V_{PA}, V_{PB}	Pulse at 1 ms reference to GND ^a	-1.6	V			
V _{EN}	Reference to GND	-0.3 to +6	1			
Maximum Continuous Switch Current		7	A			
Maximum Pulse Current	100 μs pulse	15				
ESD (HBM)		8000	V			
Operating Temperature		-40 to +85				
Operating Junction Temperature		125	°C			
Storage Temperature		-65 to +150	1			
Thermal Resistance (θ _{JA}) ^b		73	°C/W			
Power Dissipation (P _D) b, c	T _A = 70 °C	1096	mW			

Notes

- a. Negative current injection up to 300 mA
- b. All bumps soldered to 1" x 1", 2 oz. copper, 4 layers PC board
- c. Derate 13.7 mW/ $^{\circ}$ C above T_A = 70 $^{\circ}$ C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

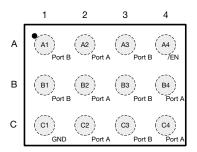
SPECIFICATIONS							
		TEST CONDITIONS UNLESS SPECIFIED	LIMITS				
PARAMETER	SYMBOL	$\begin{aligned} V_{\text{IN}} &= V_{\text{PA}}/V_{\text{PB}} = 2.3 \text{ V to } 5.5 \text{ V, } T_{\text{A}} = -40 ^{\circ}\text{C to } +85 ^{\circ}\text{C} \\ &(\text{Typical values are at } V_{\text{PA}}, V_{\text{PB}} = 4.2 \text{ V,} \\ &C_{\text{PA}}, C_{\text{PB}} = 0.1 \mu\text{F, } T_{\text{A}} = 25 ^{\circ}\text{C}) \end{aligned}$	MIN. a	TYP. b	MAX. a	UNIT	
Power Supply							
Operating voltage ^c	V _{PA/PB}		2.3	-	5.5	V	
Quiescent current	IQ	V _{EN} = V _{IN} , no load	-	110	400	nA	
Shutdown current	I _{SHDN}	V _{EN} = 0 V, no load	-	110	400	nA	
Internal FET							
On-resistance	В	$V_{PA}/V_{PB} = 2.3 \text{ V}, I_L = 500 \text{ mA}, T_A = 25 \text{ °C}$	-	8	13	mΩ	
On-resistance	R _{DS(on)}	$V_{PA}/V_{PB} = 3.3 \text{ V}, I_L = 500 \text{ mA}, T_A = 25 \text{ °C}$	-	6.5	10		
Control							
EN input logic-low voltage c	V _{IL}		-	-	0.4	V	
EN input logic-high voltage c	V _{IH}		1.4	-	-	v	
EN input logic hysteresis	V _{I(HYS)}		-	> 200	-	mV	
EN pull resistor	R _{EN}	$V_{PA}/V_{PB} = 5.5 \text{ V}, V_{\overline{EN}} \text{ (or } V_{EN}) = 2.3 \text{ V}$	-	500	700	kΩ	
Timing							
Output turn-on delay time	t _{d(on)}		ı	0.8	-		
Output turn-on rise time	t _r	$V_{IN} = 4.2 \text{ V}, R_{I} = 100 \Omega, C_{I} = 0.1 \mu\text{F}, T_{\Delta} = 25 \text{ °C}$	-	1	-	ms	
Output turn-off delay time	t _{d(off)}	$V_{IN} = 4.2 \text{ V}, \ n_L = 100 \text{ S2}, \ O_L = 0.1 \ \mu\text{F}, \ I_A = 25 \text{ G}$	-	0.12	-		
Output turn-off fall time	t _f		-	0.1	-		

Notes

- a. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum
- b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing
- c. For V_{IN} outside this range consult typical \overline{EN} , EN threshold curve



BUMP CONFIGURATION

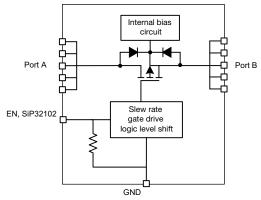


Top view (solder bumps on bottom)

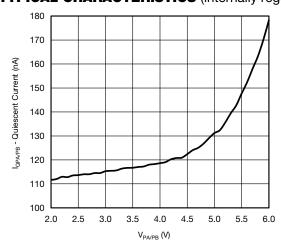
Fig. 2 - WCSP12, 1.3 mm x 1.7 mm

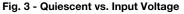
BUMP DESCRIPTION				
BUMP NUMBER	NAME	FUNCTION		
A1, B1, A3, B3, C3	PB	Power port B		
C1	GND	Ground		
A2, B2, C2, B4, C4	PA	Power port A		
A4	EN	Switch enable input, active high		

FUNCTIONAL BLOCK DIAGRAM



TYPICAL CHARACTERISTICS (internally regulated 25 °C, unless otherwise noted)





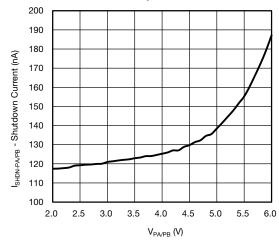


Fig. 4 - Shutdown Current vs. Input Voltage

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TYPICAL CHARACTERISTICS (internally regulated 25 °C, unless otherwise noted)

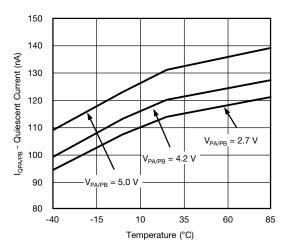


Fig. 5 - Quiescent vs. Temperature

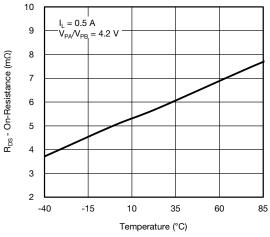


Fig. 6 - On Resistance vs. Temperature

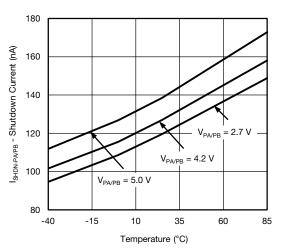


Fig. 7 - Shutdown Current vs.Temperature

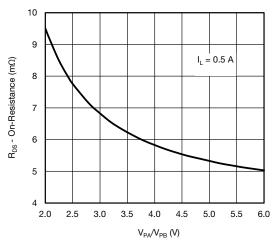


Fig. 8 - On Resistance vs. Input Voltage

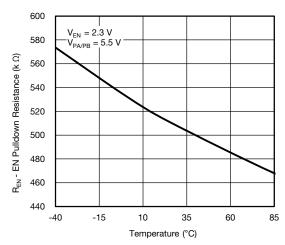


Fig. 9 - EN Pull down Resistance vs. Temperature

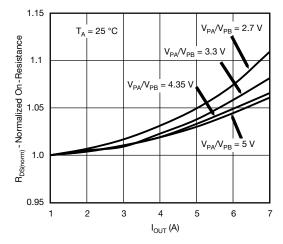


Fig. 10 - Normalized On Resistance vs. Load Current



TYPICAL CHARACTERISTICS (internally regulated 25 °C, unless otherwise noted)

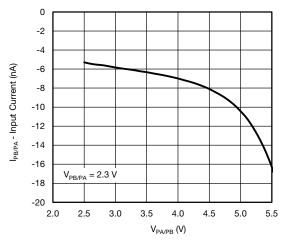


Fig. 11 - Reverse Blocking Current (I_{RB}) vs. Output Voltage

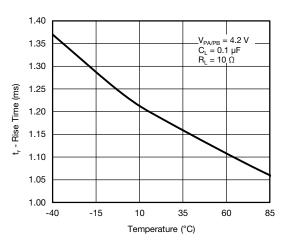


Fig. 12 - Rise Time vs. Temperature

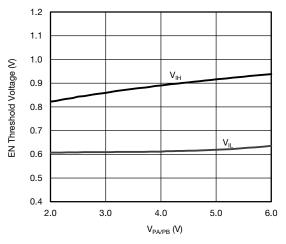


Fig. 13 - EN Threshold Voltage vs. Input Voltage

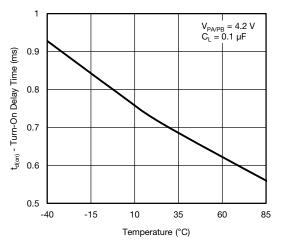


Fig. 14 - Turn-on Delay Time vs. Temperature

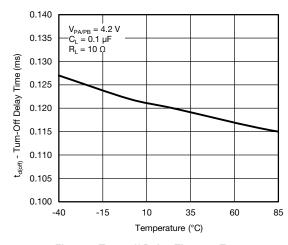


Fig. 15 - Turn-off Delay Time vs. Temperature

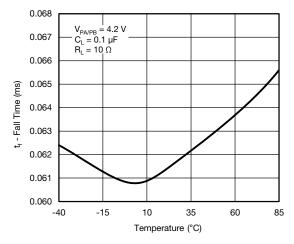


Fig. 16 - Fall Time vs. Temperature



DETAILED DESCRIPTION

The SiP32102 bidirectional switch features reverse blocking capability to isolate the battery from the system. The internal switch has an ultra low 6.5 m Ω (typ. at 3.3 V) on-resistance and operates from a +2.3 V to +5.5 V input voltage range, making the device ideal battery-disconnect switch for high capacity battery applications. The parts can handle 7 A continuous current at both directions.

The SiP32102 has slew rate control, making it ideal in large load capacitor as well as high current load switching applications.

The SiP32102 is available in an ultra compact 12-bump, 1.3 mm x 1.7 mm, 0.4 mm pitch WCSP package with top side lamination. The device operates over the temperature of -40 $^{\circ}$ C to +85 $^{\circ}$ C.

REVERSE CURRENT BLOCKING

The SiP32102 is a bidirectional switch that prevent current flowing from either port to the other when the device is disabled.

EN INPUT

The SiP32102 has an active-high enable pin that turns the switch on when high and off when low. The SiP32102 has an integrated pull down resistor at EN pin.

SWITCH ON AND OFF PERFORMANCE

The SiP32102 has a slew rate control. This minimizes the inrush current and provides a soft turn on.

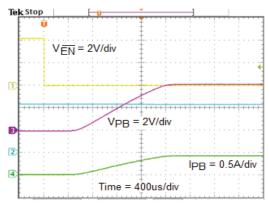


Fig. 17 - Port B Turn-On Time (V_{PA} = 4.2 V, R_L = 10 Ω , C_L = 0.1 μ F)

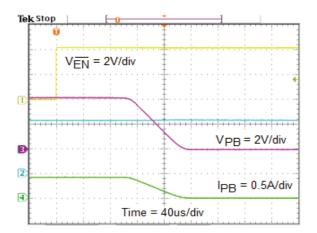


Fig. 18 - Port B Turn-Off Time (VPA = 4.2 V, RL = 10 Ω , CL = 0.1 μ F)

DEVICE PIN OUT

Device pin out is designed for ease of layout.

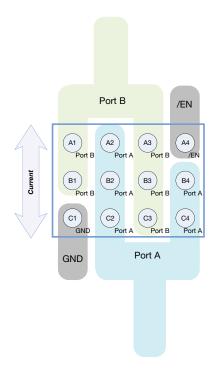


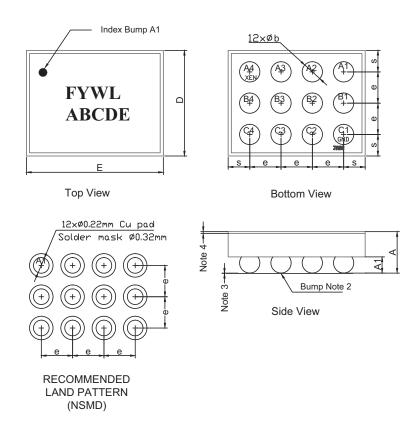
Fig. 19 - Proposed Layout

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WCSP12: 12 Bumps

(3 x 4, 0.4 mm pitch, 208 µm bump height, 1.71 mm x 1.31 mm die size)



	MILLIMETERS (5)			INCHES			
DIMENSION	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.515	0.530	0.545	0.0203	0.0209	0.0215	
A1	0.183	0.208	0.233	0.0072	0.0082	0.0092	
b	0.234	0.260	0.312	0.0092	0.0102	0.0123	
е	0.400			0.0157			
S	0.235	0.255	0.275	0.0093	0.0100	0.0108	
D	1.270	1.310	1.350	0.0500	0.0516	0.0531	
E	1.670	1.710	1.750	0.0657	0.0673	0.0689	

Notes (unless otherwise specified)

- (1) Laser mark on the silicon die back coated with an epoxy film.
- (2) Bumps are SAC396.
- (3) 0.050 max. co-planarity.
- (4) Laminate tape thickness is 0.022 mm.
- (5) Use millimeters as the primary measurement.

ECN: S13-2510-Rev. B, 16-Dec-13

DWG: 6017



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